# SN54136, SN54LS136, SN74136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES WITH OPEN-COLLECTOR OUTPUTS

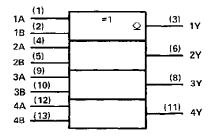
DECEMBER 1972 - REVISED MARCH 1988

UNCTION	TABLE

INP	UTS	OUTPUT
Α	8	Y
L	L	L
L	н	н
Н	L	н
Н	Н	L

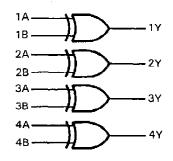
H = high level, L = low level

### logic symbol†

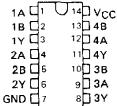


<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

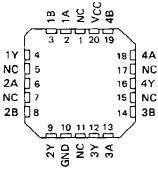
#### logic diagram (each gate)



### SN54136, SN54LS136...J OR W PACKAGE SN74136...N PACKAGE SN74LS136...D OR N PACKAGE (TOP VIEW)



SN54LS136 . . . FK PACKAGE (TOP VIEW)

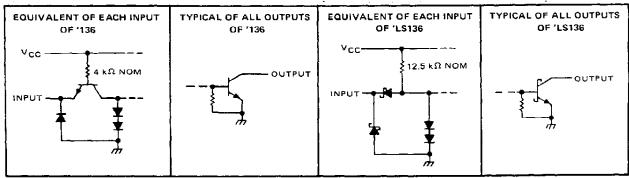


NC - No internal connection

### positive logic

$$Y = A \oplus B = \overline{A} \cdot B + A \cdot \overline{B}$$

### schematics of inputs and outputs



Resistor values shown are nominal.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include tasting of all parameters.



Pin numbers shown are for D, J, N, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .		-					 							7 '	ď
Input voltage															
Operating free-air temperature range:	SN54136				. ,		 				-5	5°C	to	125°	C
	SN74136														
Storage temperature range														150°	

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

	,	SN5413	6		UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	נועוט
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧
High-level input voltage, VIH	2			2			V
Low-level input voltage, VIL			Q.B	1		0.8	V
High-level output voltage, VOH			5.5			5.5	V
Low-level output current, IOL			16			16	mA
Operating free-air temperature, TA	- 55	-	125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		TEST CONDITIONS <sup>†</sup>				SN5413	6	;	6	UNIT	
PARAMETER		1531 0	ONDI HONS .		MIN	TYP‡	MAX	MIN	ТҮР‡	MAX	UNIT
VIΚ	VCC = MIN,	l <sub>1</sub> = -8 mA					- 1.5			- 1.5	V
loн	VCC = MIN,	V <sub>1H</sub> = 2 V,	$V_{ L} = 0.8 V$	V <sub>OH</sub> = 5.5 V						0.25	mΑ
ОН	$V_{CC} = MIN,$	V <sub>IH</sub> = 2 V.	$V_{\rm IL} = 0.7  \rm V_{\rm c}$	V <sub>OH</sub> = 5.5 V			0.25				IIIA
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	$V_{IL} = 0.8 V$ ,	1 <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V
<u> </u>	V <sub>CC</sub> = MAX,	$V_{ } = 5.5 V$					1			1	mΑ
lн	V <sub>CC</sub> = MAX,	$V_1 = 2.4 \text{ V}$				-	40			40	μΑ
IIL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V					-1.6			- 1.6	mA
lcc _	VCC = MAX,	See Note 2				30	43		30	50	mA

 $<sup>^{\</sup>dagger}$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.  $^{\ddagger}$  All typical values are at  $V_{CC}=5$  V,  $T_{A}=25$  °C.

NOTE 2:  $I_{CC}$  is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

## switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST COI	MIN	TYP	MAX	UNIT	
tрЦН	A or B	Other is out law	5 45 5		12	18	
tPHL	Aore	Other input low	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 400 Ω,		39	50	ns
tPLH	A or B	Oakaa iaawa kiak	i -		14	22	ns
tpHL	7 700	Other input high	See Note 3		42	55	] ''

 $<sup>\</sup>mathbf{1}_{\mathsf{tpLH}}$  propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

tplH propagation delay time, high-to-low-level output

# SN54LS136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES WITH OPEN-COLLECTOR OUTPUTS

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)													7 V
Input voltage													
Operating free-air temperature range	: SN54LS136	 			_						-55	°C to	o 125°C
•	SN74LS136			,					_			0°C	to 70°C
Storage temperature range													

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

	12	SN54LS136					UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	Civit
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	\ \ \
High-level output voltage, VOH			5.5			5.5	V
Low-level output current, IOL			4			8	mΑ
Operating free-air temperature, TA	-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAGAMETER	7507.001	IDITIONS	SI	V54LS1	36	SI	UNIT		
	PARAMETER	TEST CON	IDITIONS,	MIN	TYP#	MAX	MIN	TYP#	MAX	UNIT
VIH	High-level input voltage			2			2			٧
٧IL	Low-level input voltage					0.7			0.8	V
VIK	Input clamp voltage	VCC = MIN.	I <sub>I</sub> = -18 mA	1		-1.5			-1.5	V
юн	High-level output current	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>IH</sub> = 2 V, V <sub>OH</sub> = 5.5 V			100			100	μА
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
	•	VIL = VIL max	IQL = 8 mA	1				0.35	0.6	
1 <sub>1</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7 V			0.2			0.2	mΑ
ΉΗ	High-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V	1		40			40	μА
ΊL	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-0.8	T		-0.8	mA
Icc	Supply current	V <sub>CC</sub> = MAX,	See Note 2	1	6.1	10		6.1	10	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.  $^\ddagger$ All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

NOTE 2: ICC is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TEST CO	NDITIONS	MIN	ТҮР	MAX	UNIT
tpLH	A or B	Other input low	0 - 15 - 5		18	30	ns
tPHL	A 51 B	Other input low	CL = 15 pF,		18	30	
tPLH	A or B	Other input high	R <sub>L</sub> = 2 kΩ, (See Note 3)		18	30	ns
<sup>t</sup> PHL	A 01 D	Other input nigh	(588 14069 37		18	30	

<sup>1</sup>tpLH propagation delay time, low-to-high-level output

tell propagation delay time, high-to-low-level output NOTE 3: Load circuits and voltage waveforms are shown in Section 1.







15-Jan-2021

#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9231901MCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9231901MC A SNJ54LS136J	Samples
SN54LS136J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS136J	Samples
SN74LS136D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS136	Samples
SN74LS136DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS136	Samples
SN74LS136DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS136	Samples
SN74LS136N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS136N	Samples
SN74LS136NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS136N	Samples
SN74LS136NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS136	Samples
SNJ54LS136J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9231901MC A SNJ54LS136J	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: Til defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



# **PACKAGE OPTION ADDENDUM**

15-Jan-2021

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS136, SN74LS136:

Catalog: SN74LS136

Military: SN54LS136

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS136DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS136NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74LS136DR	SOIC	D	14	2500	853.0	449.0	35.0	
SN74LS136NSR	SO	NS	14	2000	853.0	449.0	35.0	

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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